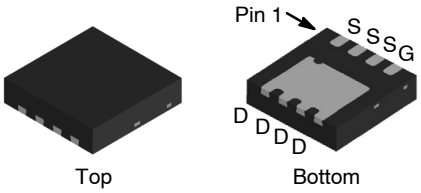
MOSFET – P-Channel, POWERTRENCH®

-150 V, -9 A, 160 mΩ

FDMC86261P

V_{DS}	$r_{DS(on)}$ MAX	I_D MAX
−150 V	160 mΩ @ −10 V	−9 A
	185 mΩ @ −6 V	



WDFN-8 3.3x3.3, 0.65P
(MLP 3.3x3.3)
CASE 511DH

General Description

This P-Channel MOSFET is produced using **onsemi**'s advanced POWERTRENCH technology. This very high density process is especially tailored to minimize on-state resistance and optimized for superior switching performance.

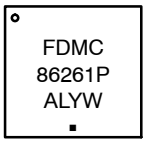
Features

- Max $r_{DS(on)}$ = 160 mΩ at V_{GS} = −10 V, I_D = −2.4 A
- Max $r_{DS(on)}$ = 185 mΩ at V_{GS} = −6 V, I_D = −2.2 A
- Very Low R_{DS-on} Mid Voltage P Channel Silicon Technology Optimised for Low Qg
- This Product is Optimised for Fast Switching Applications as Well as Load Switch Applications
- 100% UIL Tested
- This Device is Pb-Free, Halide Free and is ROHS Compliant

Applications

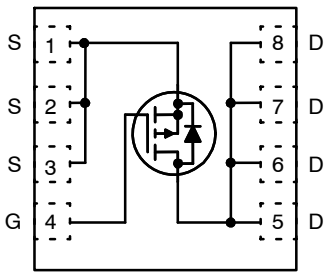
- Active Clamp Switch
- Load Switch

MARKING DIAGRAMS



FDMC86261P	= Device Code
A	= Assembly Site
L	= Wafer Lot Number
YW	= Year Workweek
▪	= Pb-Free Package

PIN ASSIGNMENT



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

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MOSFET MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

Symbol	Parameter			Ratings	Unit
V_{DS}	Drain to Source Voltage			−150	V
V_{GS}	Gate to Source Voltage			±25	V
I_D	Drain Current	Continuous	T_C = 25 °C	−9	A
		Continuous (Note 2a)	T_A = 25 °C	−2.7	
		Pulsed		−20	
E_{AS}	Single Pulse Avalanche Energy (Note 1)			121	mJ
P_D	Power Dissipation		T_C = 25 °C	40	W
	Power Dissipation (Note 2a)		T_A = 25 °C	2.3	
T_J, T_{STG}	Operating and Storage Junction Temperature Range			−55 to +150	°C

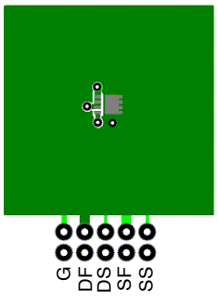
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Starting T_J = 25 °C; P-ch: L = 3 mH, I_{AS} = −9 A, V_{DD} = −150 V, V_{GS} = −10 V. 100% test at L = 0.1 mH, I_{AS} = −28 A.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 2a)	53	

2. $R_{\theta JA}$ is determined with the device mounted on a 1 in^2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 53 °C/W when mounted on a 1 in^2 pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = −250 μA, V_{GS} = 0 V	−150			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = −250 μA, referenced to 25 °C		−132		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = −120 V, V_{GS} = 0 V			−1	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±25 V, V_{DS} = 0 V			±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA	−2	−3	−4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = −250 μA, referenced to 25 °C		6		mV/°C
$r_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = −10 V, I_D = −2.4 A		130	160	mΩ
		V_{GS} = −6 V, I_D = −2.2 A		141	185	
		V_{GS} = −10 V, I_D = −2.4 A, T_J = 125 °C		218	269	
g_{FS}	Forward Transconductance	V_{DS} = −10 V, I_D = −2.4 A		9		S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = −75 V, V_{GS} = 0 V, f = 1 MHz		1021	1360	pF
C_{oss}	Output Capacitance			87	120	pF
C_{rss}	Reverse Transfer Capacitance			4.7	10	pF
R_g	Gate Resistance		0.1	1.7	3.4	Ω
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = −75 V, I_D = −2.4 A, V_{GS} = −10 V, R_{GEN} = 6 Ω		11	20	ns
t_r	Rise Time			2.4	10	ns
$t_{d(off)}$	Turn-Off Delay Time			18	33	ns
t_f	Fall Time			9.2	20	ns
$Q_{g(TOT)}$	Total Gate Charge	V_{GS} = 0 V to −10 V, V_{DD} = −75 V, I_D = −2.4 A		17	24	nC
$Q_{g(TOT)}$	Total Gate Charge	V_{GS} = 0 V to −6 V, V_{DD} = −75 V, I_D = −2.4 A		11	16	nC
Q_{gs}	Total Gate Charge	V_{DD} = −75 V, I_D = −2.4 A		4.2		nC
Q_{gd}	Gate to Drain “Miller” Charge			3.7		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_S = −2.4 A (Note 3)		−0.81	−1.3	V
		V_{GS} = 0 V, I_S = −1.9 A (Note 3)		−0.80	−1.2	
t_{rr}	Reverse Recovery Time	I_F = −2.4 A, di/dt = 100 A/μs		81	130	ns
Q_{rr}	Reverse Recovery Charge			197	315	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.

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TYPICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)

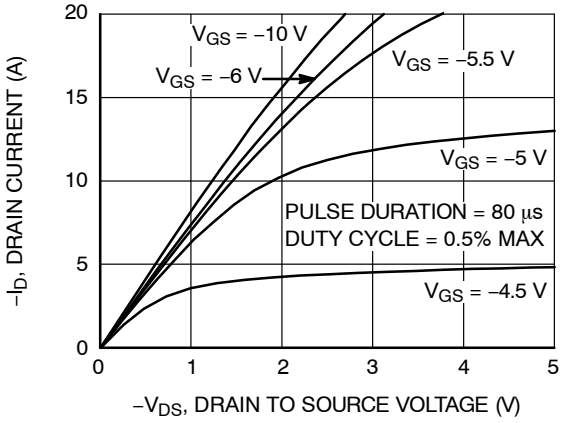


Figure 1. On-Region Characteristics

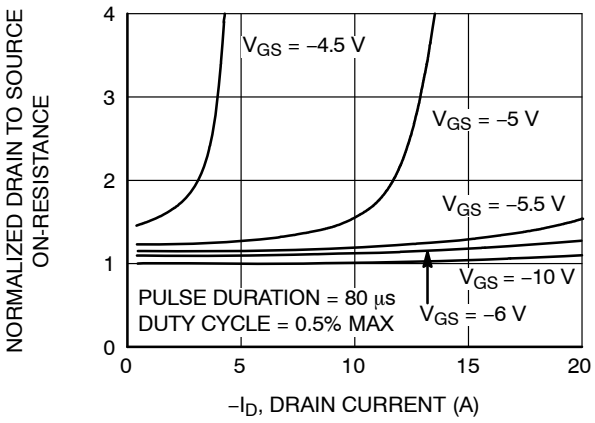


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

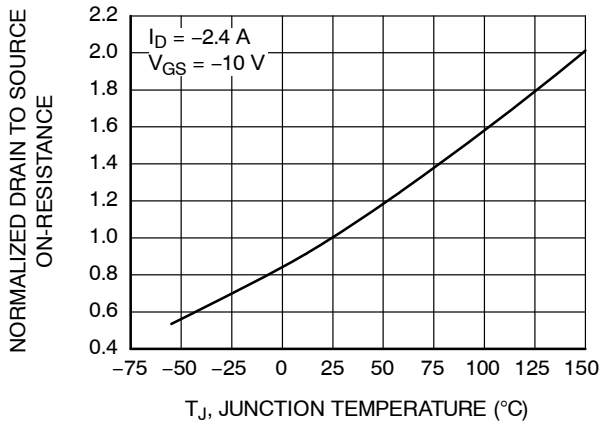


Figure 3. Normalized On-Resistance vs. Junction Temperature

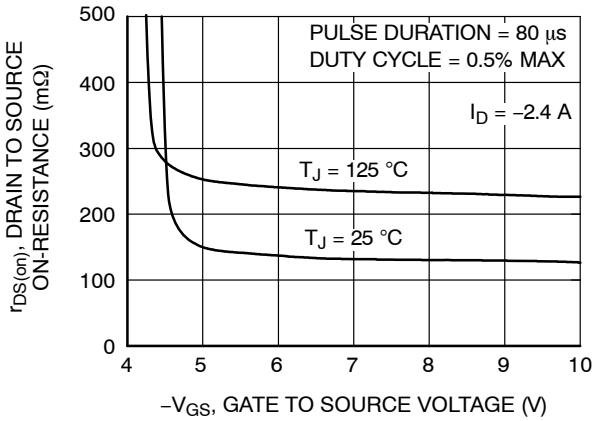


Figure 4. On-Resistance vs. Gate to Source Voltage

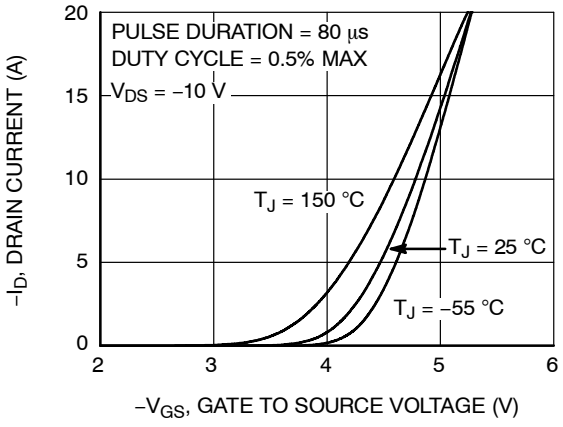


Figure 5. Transfer Characteristics

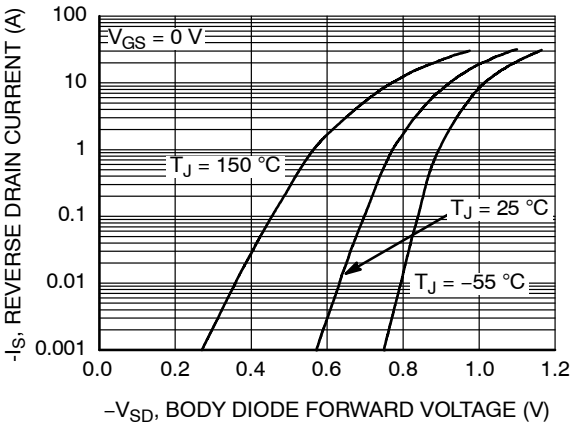


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

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TYPICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted) (continued)

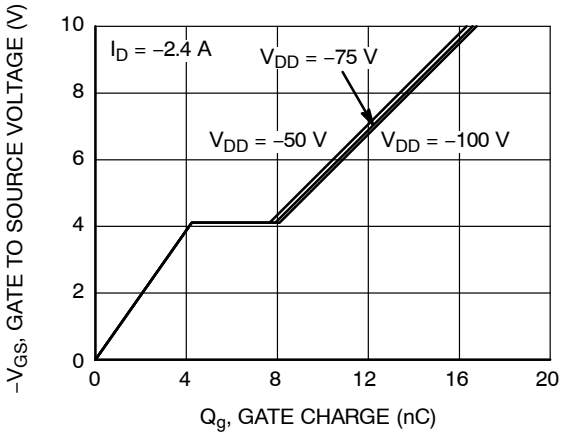


Figure 7. Gate Charge Characteristics

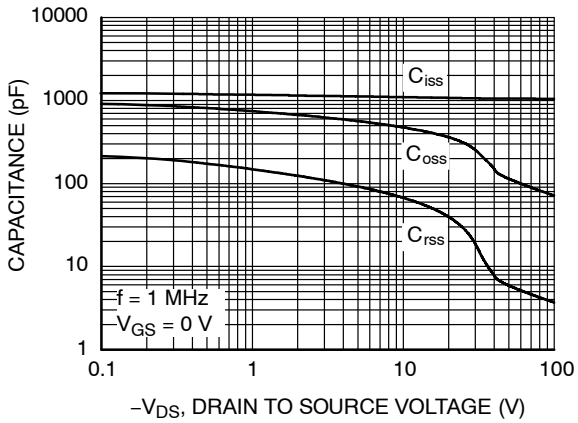


Figure 8. Capacitance vs. Drain to Source Voltage

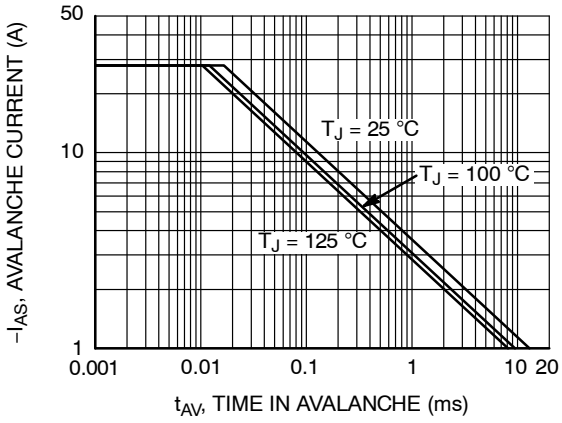


Figure 9. Unclamped Inductive Switching Capability

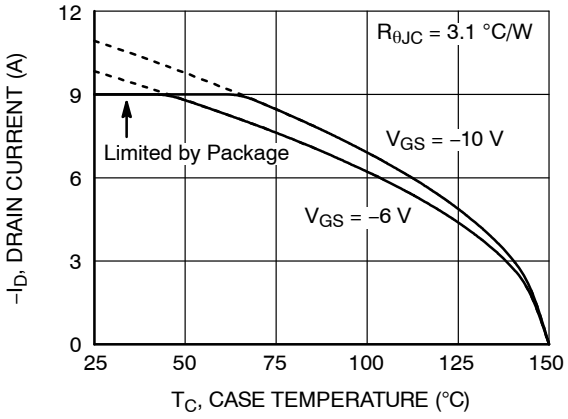


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

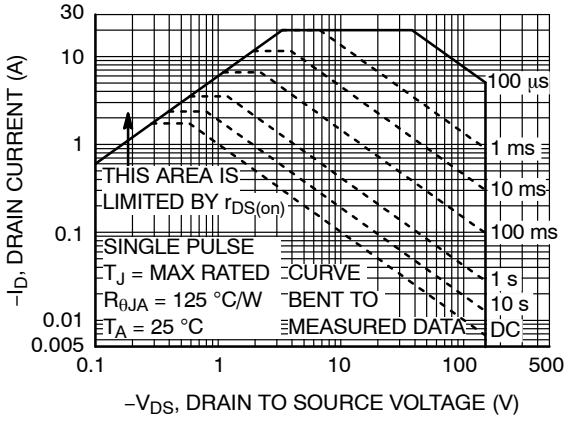


Figure 11. Forward Bias Safe Operating Area

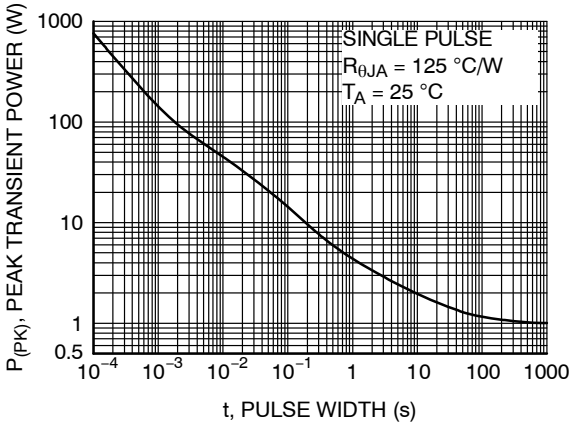


Figure 12. Single Pulse Maximum Power Dissipation

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TYPICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted) (continued)

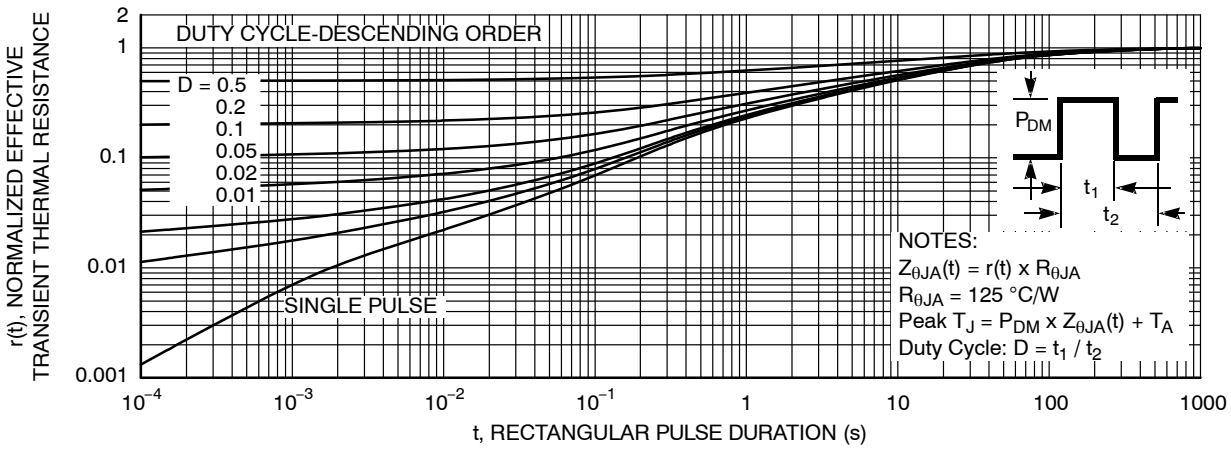


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package Type	Reel Size	Tape Width	Shipping†
FDMC86261P	FDMC86261P	WDFN8 3.3x3.3, 0.65P Power 33 (Pb−Free, Halide Free)	13”	12 mm	3,000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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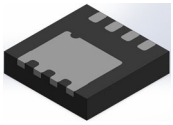
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REVISION HISTORY

Revision	Description of Changes	Date
4	Adding Pb dot and Change the Marking Diagram on page 1 to follow onsemi format.	11/3/2026

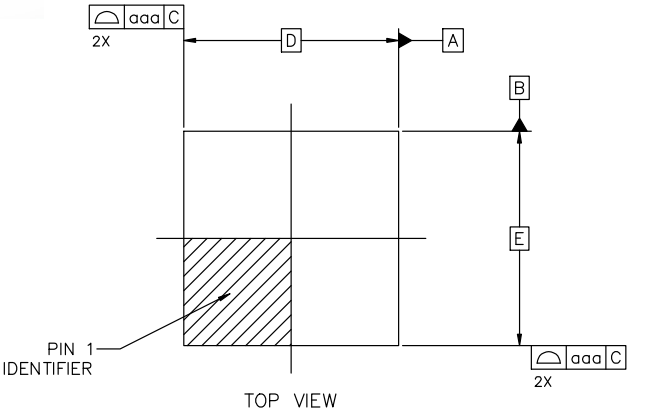
This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

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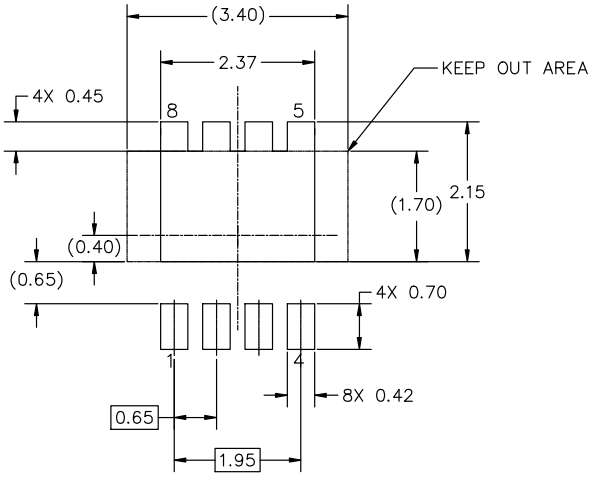
WDFN−8 3.30x3.30x0.75, 0.65P
CASE 511DH
ISSUE A

DATE 04 DEC 2025



NOTES:
1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.025	0.05
A3		0.20 REF	
b	0.30	0.35	0.40
D		3.30 BSC	
D2	2.22	2.27	2.32
E		3.30 BSC	
E2	1.95	2.00	2.05
e		0.65 BSC	
k		0.80 REF	
k1		0.50 REF	
L	0.45	0.50	0.55
L1	0.25	0.30	0.35
TOLERANCE FORM & POSITION			
aaa		0.05	
bbb		0.10	
ccc		0.10	
ddd		0.05	
eee		0.08	



RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb−Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques reference manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	**98AON13625G**	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	**WDFN−8 3.30x3.30x0.75, 0.65P**	**PAGE 1 OF 1**

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Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

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Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

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